

# PLM Components Innovation Conference



## 2026 Agenda

April 28-29, 2026

Downing College, Cambridge | UK

**SIEMENS**

# Agenda Day 1 – April 28

## Morning

Registration 07:00 AM – 07:50 AM	
Welcome and Keynote 08:00 AM – 08:45 AM	Bob Haubrock - Siemens
Main sessions, 30 mins each 08:45 AM – 10:15 AM	Hugo Nordell - Encube
	Michael Bogomolny - Informatix
	Al Whatmough – Toolpath Labs
Break 10:15 AM	
Main sessions, 30 mins each 10:45 AM – 12:15 PM	Phil Nanson – Parasolid Components - Siemens
	Andrew Sartorelli - Synera
	Michael Finocchiaro – Finocchiaro consulting
Lunch 12:15 PM	

## Afternoon

Panel discussion: Artificial Intelligence Moderated by Monica Schnitger 01:15 PM – 02:15 PM	
Main sessions, 30 mins each 02:15 PM – 03:15 PM	Ambroise Confetti – Kineo Components - Siemens
	Jens Fetzer - Cenit
Break 03:15 PM	
Main sessions, 30 mins each 03:45 PM – 05:15 PM	Dan Watkins – Red Bull Technology
	Dan Staples – SolidEdge OEM - Siemens
	Chun Qing Li – Kreodx
Adjourn day 1 05:15 PM	
Evening reception and dinner 07:00 PM	

# Agenda Day 2 – April 29

## Morning

Registration 07:00 AM – 07:50 AM	
Main sessions, 30 mins each 08:00 AM – 10:00 AM	Giampaolo Pagnutti – Altair - Siemens
	Tom Gill - CIMdata
	Peter Knight – D-Cubed Components - Siemens
	Stephen Graham - Hexagon
Break 10:00 AM	
Main sessions, 30 mins each 10:30 AM – 12:00 PM	Bart Van der Schueren - Materialise
	George Allen, Bradley Rothenberg - nTop
	Paul Chastell – PTC Onshape
Lunch 12:00 PM	

## Afternoon

Panel discussion: Broadening Paradigms of geometry representation Moderated by Monica Schnitger 01:00 PM – 02:00 PM	
Main sessions, 30 mins each 02:00 PM – 03:00 PM	Simone Bonino - Sandvik
	Mark Driscoll, Olexiy Kilyakov – AMC Bridge
Break 03:00 PM	
Main sessions, 30 mins each 03:30 PM – 04:30 PM	Jonathan Girroir – Tech Soft 3D
	Kostadin Vrantzaliev - Quicksurface
Closing remarks 04:30 PM	

# Speakers

## SIEMENS

**Ambroise Confetti**  
Product owner  
Kineo components

**Bob Haubrock**  
Sr Vice President  
Product Engineering  
Software

**Peter Knight**  
Product manager  
D-Cubed components

**Phil Nanson**  
Director  
Parasolid components

**Giampaolo Pagnutti**  
Vice President  
Software  
Development  
Altair

**Dan Staples**  
Vice President  
Mainstream Engineering  
R&D

## SIEMENS

## Customers, partners and analysts

**Michael Bogomolny**  
CEO  
Infinitform

**Simone Bonino**  
Global Product Director  
Cimatron, Sandvik group

**Mark Driscoll and  
Olexiy Kilyakov**  
Sr Director of Sales and  
Director of Tech. Sales  
AMC Bridge Inc.

**Jens Fetzer**  
SVP Digital Factory  
solutions  
CENIT

**Michael Finocchiaro**  
Sr. industry analyst  
Finocchiaro Consulting

**Tom Gill**  
Principal consultant  
CIMdata

**Jonathan Girroir**  
Sr. Director  
Toolkit marketing  
Tech Soft 3D

**Stephen Graham**  
Executive VP and GM  
Hexagon

**Paul Chastell**  
Technical VP, R&D  
Onshape  
PTC

**Chun Qing Li**  
CEO  
Kreodx

**Hugo Nordell**  
Founder and CEO  
Encube

**Bradley Rothenberg  
and George Allen**  
CEO and Fellow,  
nTop

**Andrew Sartorelli**  
Head of product  
management  
Synera

**Bart Van der Schueren**  
CSTO  
Materialise

**Kostadin Vrantzaliev**  
Founder  
Quicksurface

**Dan Watkins**  
Group Head of Digital  
Engineering Systems  
Red Bull Racing

**Al Whatmough**  
CEO  
Toolpath Labs



**Register today**